

Substitute for H.R. 1449A/PTO

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(use as many sheets as necessary)

Sheet	1	of	5
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Complete if Known

Application Number	10/042,549
Filing Date	January 9, 2002
First Named Inventor	MICHALUK
Art Unit	1742
Examiner Name	Lois L. Zheng
Attorney Docket Number	CPM00029CIP (3600-328-01)

U.S. PATENT DOCUMENTS

[illegible]

FOREIGN PATENT DOCUMENTS

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**Examiner
Signature**

Date Considered

8/1/06

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<div style="font-size: 2em; margin-top: 10px;">llb</div> <div style="border-left: 2px solid black; height: 100px; margin-left: 10px;"></div> <div style="font-size: 2em; margin-top: 10px;">✓</div>		LASSILA et al., "Mechanical Behavior of Tantalum and Tantalum-Tungsten Alloys: Texture Gradients and Macro/Micro-Response," 14 th U.S. ARMY SYMPOSIUM ON SOLID MECHANICS, November 30, 1996 (14 pgs.)		
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		MICHALUK et al., "The Effect of Oxygen, Grain Size, and Strain Rate on the Mechanical Behavior of Forged P/M Tantalum," date unknown (pp. 195-204)		
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